

Results

Figure 1 | Photoluminescence response for CH<sub>3</sub>NH<sub>3</sub>PDI<sub>3-x</sub>Cl<sub>x</sub> perovskite films coated with *p*- and *n*-type layers to ascertain their charge transfer compatibility. (a) Steady-state photoluminescence spectra of *p*-type quenchers and (b) *n*-type quenchers of perovskite films processed in a bi-layer configuration. For the *p*-type quenchers, the perovskite was coated on top of the *p*-type collection layers, whereas for the *n*-type quenchers, the perovskite was first processed on glass slides, then the *n*-type charge collection layers were spin coated on top. Perovskite excitation at 530 nm was performed from the opposite side of the quencher.

quench the perovskite steady-state PL more efficiently than the archetypal 2,2',7,7'-Tetrakis[N,N-di(4-methoxyphenyl)amino]-9,9'-spirobifluorene (spiro-OMeTAD) p-type hole conductor previously employed in the MSSCs, with similar values for PEDOT:PSS and  $V_2O_5$  of 99.8% quenching efficiency. All the n-type layers exhibit significantly higher quenching rates than the TiO<sub>2</sub> compact layers previously employed. Our observation of enhanced PL quenching with PCBM, is consistent with our previous work where we looked at electron transfer from the perovskite absorber to fullerene self-assembled monolayers, indicating that organic electron and hole acceptors are highly effective when interfaced with the perovskite absorbers<sup>21</sup>. All the cells fabricated in this work utilize a spin coated PCBM layer as the n-type contact, since solar cells fabricated with a PFN interlayer yielded an extremely poor photovoltaic performance.

When applied to devices, NiO and  $V_2O_5 p$ -type layers resulted in rather poor photovoltaic performance (Supplementary Fig. S1), showing signs of high series resistance and for  $V_2O_5$  a low shunt resistance in the *J*-*V* curves. This is likely to arise in part from extremely poor perovskite film formation upon the substrate, with very poor surface coverage (Supplementary Fig. S2). This will enable direct contact of the PCBM *n*-type layer with the *p*-type metal oxide, presenting a shunting path. In addition, the high series resistance may arise from low conductivity of the *p*-type oxide, suggesting improvements could be made by controlling the conductivity or doping density in the *p*-type oxide, and improving the film formation of the perovskite upon the flat metal oxide layers. In contrast, when a thin PEDOT:PSS layer is used as the *p*-type contact, a solid perovskite absorber

Table 1   Steady-state photoluminescence quenching   efficiency.				
p-type layers		n-type layers		
NiO	95	PCBM	91	
V <sub>2</sub> O <sub>5</sub>	99.8	PFN	99.8	
PEDOT:PSS Spiro-OMeTAD	99.8 99.1	TiO <sub>2</sub>	47	

The photoluminescence quenching from the perovskite was quantified for both p- and n-type charge collection layers contacting the perovskite absorber. The quenching efficiency was calculated by integrating the photoluminescence spectra over wavelength and comparing with the neat perovskite layer. We note that this is not measured in an integrating sphere, so only represents an estimation of the quenching efficiency.

layer exhibiting over 95% surface coverage is achieved, as estimated from scanning electron microscopy (SEM) images, and the conductivity of the PEDOT:PSS is controlled and high. This results in good photovoltaic properties when a bi-layer of PCBM and compact  $TiO_x$  is employed as the *n*-type charge collection layer. The origin of the different perovskite film formation characteristics on the different *p*-type layers is not completely understood at this moment and will be the subject of a future study, but is likely to originate from differences in surface roughness and perovskite/surface interaction energy<sup>22</sup>. To be able to process these structures in air, the top interlayer of  $TiO_x$  was necessary to achieve a stable electronic contact with the top Al anode (Supplementary Fig. S3)<sup>23</sup>. A cross-sectional SEM image of an optimized device is presented in Fig. 2.

Photovoltaic performance. We show the photovoltaic performance of the inverted device structure in comparison with that of the regular MSSC device architecture (composed of a compact TiO<sub>2</sub> electron accepting layer, low temperature processed mesoporous alumina film filled with perovskite absorber and spiro-OMeTAD as the hole transporting layer) in Fig. 3. The best performing device with the inverted architecture achieved a short-circuit photo current approaching  $16 \text{ mA cm}^{-2}$ , open-circuit voltages of over 0.9 V and 9.8% PCE, closely matching initial reports with devices based on the standard architecture. We also stress that this is achieved in a planar configuration, where no nanostructured scaffold is present and the total active layer thickness is around 300 nm. This good operation of the solid perovskite layer is consistent with our recent results where a planar heterojunction of a similar thickness composed of TiO<sub>2</sub>/ CH<sub>3</sub>NH<sub>3</sub>PbI<sub>3-x</sub>Cl<sub>x</sub>/Spiro-OMeTAD delivered over 15% PCE<sup>14</sup>. The PCE value shown here for inverted perovskite solar cells is higher than the best published single junction organic solar cells<sup>19,24</sup>, similar to the highest efficiencies for a-Si, and compares favourably with early reports of alternative thin-film technologies such as copper indium gallium (di) selenide, cadmium telluride<sup>25</sup>, with significant further improvements expected in the very near future<sup>15</sup>. A histogram for the PCE of a set of around 40 devices is also shown in Supplementary Fig. S4 as well as the photovoltaic performance of an inverted device under a series of light intensities from full AM 1.5 sunlight conditions to low <1% sunlight irradiation in Supplementary Fig. S5.

It is important to note that the J-V curves presented in this work were measured after aging the samples under constant light



**Figure 2 | Optimized device structure. (a)** SEM. cross-sectional image of the optimized inverted device configuration. Scale bar represents 250 nm. The different layers have been tinted with the colour scheme of the device schematic shown in (b). (c) Approximate energy band diagram of the fabricated inverted structure taken from reference<sup>21</sup>.

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**Figure 3 | Photovoltaic performance characteristics. (a)** Current voltage curves for champion devices of regular MSSC (red circles) and inverted planar-heterojunction (blue triangles) configuration. Inset shows the short-circuit current density ( $J_{scr}$  mA cm<sup>-2</sup>), power-conversion efficiency (Eff, %), open-circuit voltage ( $V_{ocr}$ , V) and FF for both device architectures. (b) Incident photon-to-electron conversion efficiency against wavelength for a typical inverted device. The integrated current from the product of the incident photon-to-electron conversion efficiency and the AM 1.5 100 mW cm<sup>-2</sup> solar spectrum is 16.5 mA cm<sup>-2</sup>, in close agreement to the short-circuit photocurrent measured under simulated sunlight.



**Figure 4 | Flexible solar cell performance. (a)** Picture of the first flexible perovskite solar cell and (b) *J-V* curves for inverted architecture devices fabricated both on ITO-covered glass and PET, measured under-simulated AM 1.5 100 mW cm<sup>-2</sup> sunlight. The inset table shows the photovoltaic performance parameters,  $J_{sc}$  (mA cm<sup>-2</sup>), efficiency (%),  $V_{oc}$  (V) and FF.

illumination for a number of minutes. The initial current voltage curve typically exhibit a little over >1% PCE, but increased to between 7.5–10% after around 10 minutes of constant illumination and operation in air (Supplementary Fig. S6). This is not the case for the regular MSSC that operates well immediately. The requirement for light soaking of TiO<sub>x</sub> is consistent with previous reports in organic photovoltaics<sup>26</sup>.

Flexible solar cells. Finally, enabled by the 'all low-temperature' processing, we have also fabricated inverted perovskite devices on ITO-coated poly(ethylene terephthalate) (PET) substrates, shown in Fig. 4. Devices fabricated on either ITO-covered glass or PET exhibited essentially the same photovoltaic performance parameters, with short-circuit currents of over 14 mA cm<sup>-2</sup>, opencircuit voltages of around 0.9 V and power-conversion efficiencies of over 6.3%. The main difference between devices fabricated on ITO- and FTO-covered glass is the lower fill factor (FF) and current of the ITO devices. This may in part be accommodated by the batch-to-batch variation, but is likely to also arise from poorer perovskite film formation and lower surface coverage upon the PEDOT:PSS-coated ITO as opposed to the PED-OT:PSS-coated FTO, as shown in Supplementary Fig. S7. The main difference between FTO and ITO is the surface roughness, with the latter being much smoother. It is likely that the roughness of the FTO is an important factor in enabling more uniform perovskite coating and ensuing better operation of these inverted

perovskite solar cells, which do not incorporate any mesoporous scaffold.